SE10 Series

The most versatile product in our ThinkEdge portfolio.

These compact yet powerful devices balance environmental requirements with reliable performance and effortless deployment and maintenance. This technology was created to solve some of the toughest challenges you face when it comes to capturing data at the outermost edge for your business. From extreme temperatures to the most constrained spaces, SE10 users can now scale the spectrums of ruggedness and flexibility thanks to the ground up modular design.

Unconstrained Entry Performance
Intel ATOM dual and quad core processors allow these compact, yet powerful edge clients to perform unconstrained.

Modular Design
The SE10 addresses variations with a ground up modular design, allowing users to scale up and down the spectrums of ruggedness and flexibility.

Easy Deployment and Maintenance
Compatible design to meet VESA, DIN, ThinkCentre Tiny mounting and 3 years life cycle

Environmental Adaptability
Purposefully designed & Mil-STD compliant to be configured to adapt to a broad range of Edge vertical applications

Popular Use Cases:
Retail
Manufacturing
Smart Spaces
Logistics
SE10
Series Packs A Punch

No edge environment is created exactly the same, and the features and functionalities you need from your edge devices often vary. This is why we’re changing the game in versatility within our ThinkEdge portfolio.

ThinkEdge SE10
Computing Versatility

- **OS**: Win10 IoT LTSC Ubuntu Server, Ubuntu Core
- **CPU**: Intel ATOM Elkhart 6/12W (up to 4 Cores)
- **RAM**: 2x So-DIMM up to 32GB DDR4 Memory
- **Storage**: 1x M.2 SSD up to 1T, 1x SD
- **Form Factor**: 0.8L Fanless, Ruggedized, Option IP50 kits
- **Connectivity**: USB, Serial, HDMI, DP, GbE, Wi-Fi, 4G
- **Power**: 110/220 AC adapter
- **Temp range**: 0-50C

**Use Cases:**
Retail, Hospitality, QSR Smart Spaces, Building Automation

ThinkEdge SE10-I
Computing Reliability

- **OS**: Win10 IoT LTSC Ubuntu Server, Ubuntu Core
- **CPU**: Intel ATOM Elkhart 6W (2 Cores)
- **RAM**: 2x So-DIMM up to 32GB DDR4 Memory
- **Storage**: 64GB eMMC, 1x M.2 SSD up to 1T, 1x SD
- **Form Factor**: 1.4L Fanless, Ruggedized, Option IP50 kits
- **I/O**: 4xUSB, 2xSerial, HDMI, DP, 2xGbE, MIC-in, Line-out
- **I/O option**: DIO, CAN or Serial or PoE
- **Wireless**: Wi-Fi/BT, 4G
- **Power**: 9-36V DC input
- **Temp range**: -20°-60°C

**Use Cases:**
Manufacturing, Logistics, Smart Spaces, Building Automation